

1nV/ $\sqrt{\text{Hz}}$  420MHz GBW, 180V/ $\mu\text{s}$ ,  
Low Distortion Rail-to-Rail Output Op Amps

**FEATURES**

- Ultra Low Voltage Noise: 1nV/ $\sqrt{\text{Hz}}$
- Low Distortion: HD2/HD3 < -90dB<sub>C</sub> at 4V<sub>P-P</sub>, 1MHz into 1k $\Omega$
- High Slew Rate: 180V/ $\mu\text{s}$
- GBW = 420MHz
- -3dB Frequency (A<sub>V</sub> = +1): 330MHz
- Input Common Mode Range Includes Negative Rail
- Output Swings Rail-to-Rail
- Supply Current: 5.5mA/Channel Typ
- Operating Supply Range: 2.8V to 11.75V
- Input Offset Voltage: 95 $\mu\text{V}$  Max
- Offset Drift :0.4 $\mu\text{V}/^\circ\text{C}$
- Low Power Shutdown
- Very High Open Loop Gain: 9V/ $\mu\text{V}$  (139dB), R<sub>L</sub> = 1k $\Omega$
- Operating Temp Range: -40 $^\circ\text{C}$  to 125 $^\circ\text{C}$
- Single in 8-Lead SOIC, TSOT-23, 2mm x 2mm DFN.  
Duals in 3mm x 3mm DFN, MS8E

**APPLICATIONS**

- Optical Electronics: Fast AC-Coupled Transimpedance Amplifiers
- Driving High Dynamic Range A/D Converters
- Active Filters
- Video Amplifiers
- Low Voltage Low Distortion Amplification

**DESCRIPTION**

The LTC<sup>®</sup>6226/LTC6227 are very fast, low noise rail-to-rail output, unity gain stable single/dual op amps, with a gain-bandwidth product of 420MHz and a slew rate of 180V/ $\mu\text{s}$ . The low input referred voltage noise of only 1nV/ $\sqrt{\text{Hz}}$  and low distortion of less than -90dB<sub>C</sub> for 4V<sub>P-P</sub> signals at 1MHz makes them ideal for applications that require high dynamic range and deal with very fast signals, such as driving A/D converters.

The combination of low offset, low offset drift, high gain (139dB) and high CMRR (114dB) make these excellent devices for high dynamic range applications.

The LTC6226 family maintains excellent performance for supply voltages of 2.8V to 11.75V and the devices are fully specified at supplies of 3V, 5V and 10V ( $\pm 5\text{V}$ ).

With an input range extending to the negative rail and rail-to-rail output stage, the operational amplifier can accommodate wide swinging signals, and true single supply operation.

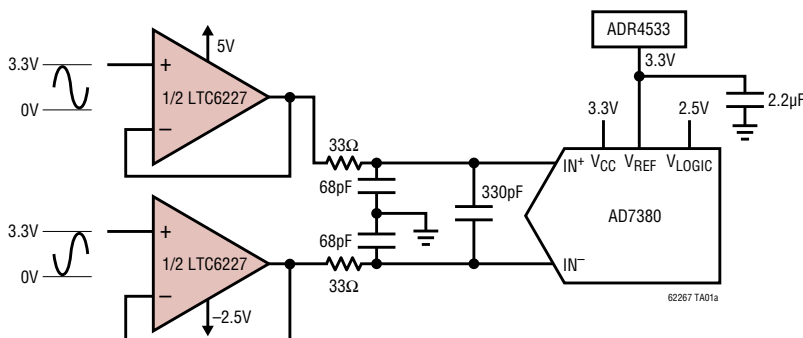
For space constrained applications, the amplifiers come in 2mm x 2mm DFN (single) and 3mm x 3mm DFN (dual) packages. The devices are also available in 8-lead SOIC, TSOT-23 and MS8E.

These amplifiers can be used as replacements for many high speed op amps to improve speed, noise and dynamic range.

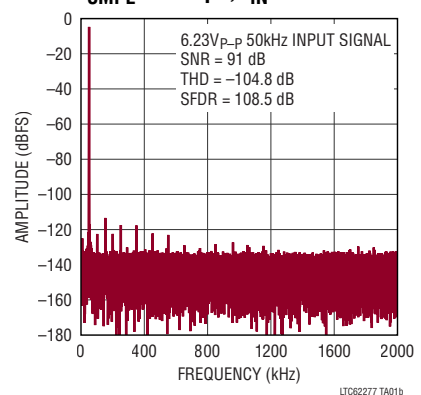
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**TYPICAL APPLICATION**

High Performance Transparent LTC6227 Based Driver for the 16-Bit AD7380



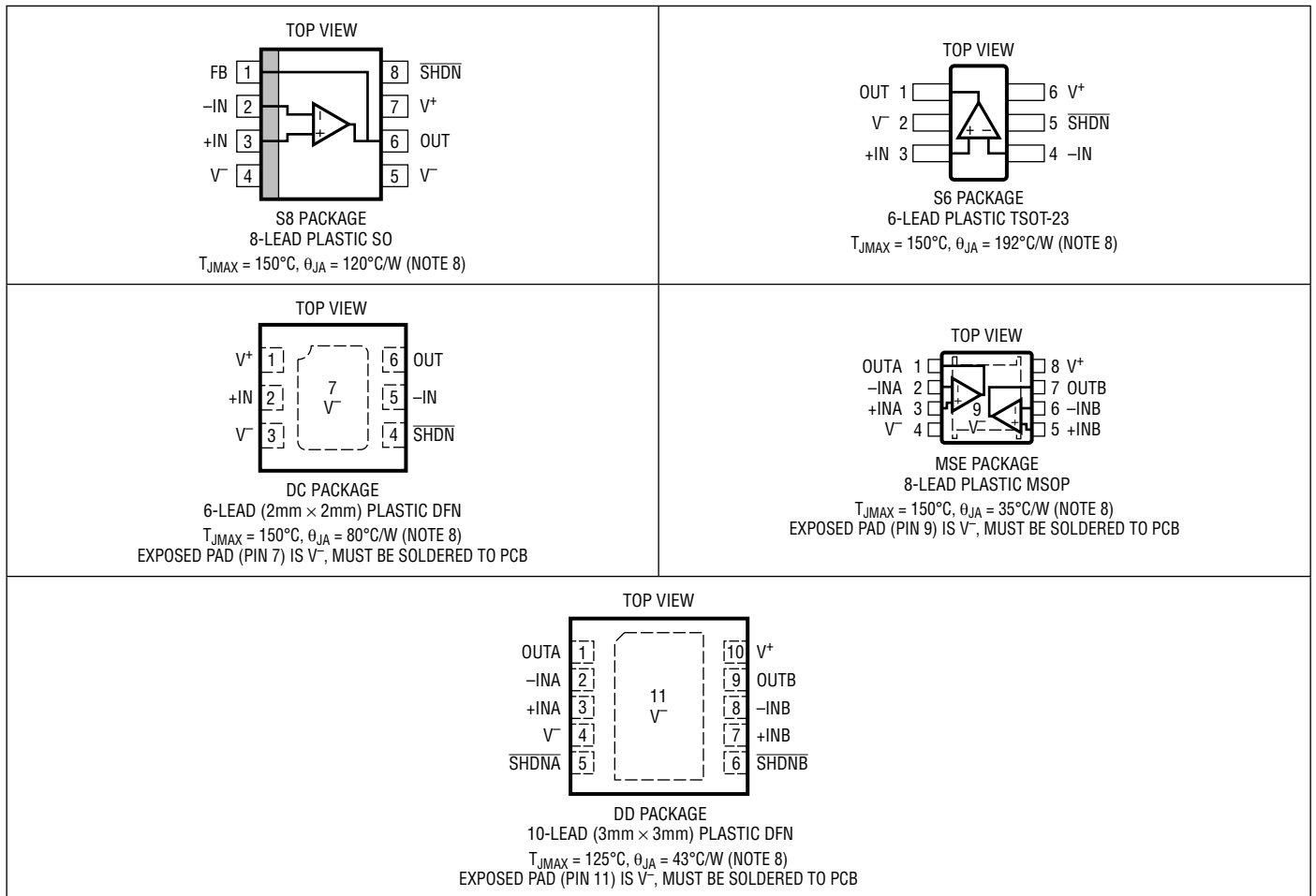
16-Bit ADC Driver Performance  
Input Signal = -0.5dBFS  
f<sub>SMPL</sub> = 4Msps, f<sub>IN</sub> = 50kHz



## ABSOLUTE MAXIMUM RATINGS (Note 1)

Total Supply Voltage ( $V^-$ to $V^+$ ) .....	12V	Output Current (Note 3) .....	$\pm 100\text{mA}$
Input Voltage ( $-IN$ , $+IN$ , $\overline{SHDN}$ )....	$V^- - 0.3\text{V}$ to $V^+ + 0.3\text{V}$	Output Short-Circuit Duration .....	Thermally Limited
Input Current ( $-IN$ , $+IN$ , $\overline{SHDN}$ ) (Note 2).....	$\pm 10\text{mA}$	Storage Temperature Range .....	$-65^\circ\text{C}$ to $125^\circ\text{C}$
Operating Temperature Range		Maximum Junction Temperature .....	$150^\circ\text{C}$
LTC6226I/LTC6227I (Note 4) .....	$-40^\circ\text{C}$ to $85^\circ\text{C}$	MSOP Lead Temperature (Soldering 10s) .....	$300^\circ\text{C}$
LTC6226H/LTC6227H (Note 4) .....	$-40^\circ\text{C}$ to $125^\circ\text{C}$		
Specified Temperature Range			
LTC6226I/LTC6227I (Note 4) .....	$-40^\circ\text{C}$ to $85^\circ\text{C}$		
LTC6226H/LTC6227H (Note 4) .....	$-40^\circ\text{C}$ to $125^\circ\text{C}$		

## PIN CONFIGURATION



## ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC6226IS6#TRMPBF	LTC6226IS6#TRPBF	LTHGY	6-Lead TSOT-23	-40°C to 85°C
LTC6226HS6#TRMPBF	LTC6226HS6#TRPBF	LTHGY	6-Lead TSOT-23	-40°C to 125°C
LTC6226IDC#TRMPBF	LTC6226IDC#TRPBF	LHGZ	6-Lead 2mm × 2mm DFN	-40°C to 85°C
LTC6226HDC#TRMPBF	LTC6226HDC#TRPBF	LHGZ	6-Lead 2mm × 2mm DFN	-40°C to 125°C
LTC6226IS8#PBF	LTC6226IS8#TRPBF	6226	8-Lead SOIC-8	-40°C to 85°C
LTC6226HS8#PBF	LTC6226HS8#TRPBF	6226	8-Lead SOIC-8	-40°C to 125°C
LTC6227IMS8E#PBF	LTC6227IMS8E#TRPBF	LTHHB	8-Lead MSOP, Exposed Pad	-40°C to 85°C
LTC6227HMS8E#PBF	LTC6227HMS8E#TRPBF	LTHHB	8-Lead MSOP, Exposed Pad	-40°C to 125°C
LTC6227IDD#PBF	LTC6227IDD#TRPBF	LHHC	10-Lead 3mm × 3mm DFN	-40°C to 85°C
LTC6227HDD#PBF	LTC6227HDD#TRPBF	LHHC	10-Lead 3mm × 3mm DFN	-40°C to 125°C

Contact the factory for parts specified with wider operating temperature ranges.

[Tape and reel specifications](#). Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

## ELECTRICAL CHARACTERISTICS ( $V_S = \pm 5V$ )

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_S = \pm 5V$ ,  $V_{CM} = 0V$ ,  $V_{SHDN}$  = floating unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$V_{OS}$	Input Offset Voltage		-95 -225	20	95 225	$\mu\text{V}$ $\mu\text{V}$
$\Delta V_{OS}$	Input Offset Voltage Match (Channel to Channel, LTC6227, Note 5)		-140 -400	18	140 400	$\mu\text{V}$ $\mu\text{V}$
$T_{CVOS}$	Input Offset Voltage Drift			0.4		$\mu\text{V}/^\circ\text{C}$
$I_B$	Input Bias Current (Note 6)		-20 -25	-8.4		$\mu\text{A}$ $\mu\text{A}$
$\Delta I_B$	Input Bias Current Match (Channel to Channel, LTC6227, Note 5)		-2 -3	0.3	2 3	$\mu\text{A}$ $\mu\text{A}$
$I_{OS}$	Input Offset Current		-0.35 -0.5	0.2	0.35 0.5	$\mu\text{A}$ $\mu\text{A}$
$\Delta I_{OS}$	Input Offset Current Match (Channel to Channel, LTC6227, Note 5)		-0.7 -1	0.15	0.7 1	$\mu\text{A}$ $\mu\text{A}$
$e_n$	Input Noise Voltage Spectral Density	$f = 1\text{MHz}$		1		$\text{nV}/\sqrt{\text{Hz}}$
	Integrated 1/f Noise	0.1Hz to 10Hz		0.77		$\mu\text{V}_{P-P}$
$i_n$	Input Noise Current Spectral Density	$f = 1\text{MHz}$		2.4		$\text{pA}/\sqrt{\text{Hz}}$
$C_{IN}$	Input Capacitance	Differential Mode Common Mode		3 1		$\text{pF}$ $\text{pF}$
$R_{IN}$	Input Resistance	Differential Mode Common Mode		4.7 6		$\text{k}\Omega$ $\text{M}\Omega$
$A_{VOL}$	Large Signal Voltage Gain	$R_L = 1\text{k}\Omega$ to Half Supply $V_{OUT} = \pm 4V$	114 110	139		$\text{dB}$ $\text{dB}$
		$R_L = 100\Omega$ to Half Supply $V_{OUT} = \pm 2.5V$	93 88	110		$\text{dB}$ $\text{dB}$
CMRR	Common Mode Rejection Ratio	$V_{CM} = V^- - 0.1V$ to $V^+ - 1.2V$	100 95	114		$\text{dB}$ $\text{dB}$
$V_{CMR}$	Input Common Mode Range (Note 10)		$V^- - 0.1$		$V^+ - 1.2$	V
PSRR <sup>+</sup>	Positive Power Supply Rejection Ratio	$V^- = -1V$ , $V^+ = 1.8V$ to $10.75V$	100 95	115		$\text{dB}$ $\text{dB}$

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## ELECTRICAL CHARACTERISTICS ( $V_S = \pm 5V$ )

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ C$ .  $V_S = \pm 5V$ ,  $V_{CM} = 0V$ ,  $V_{SHDN}$  = floating unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
PSRR <sup>-</sup>	Negative Power Supply Rejection Ratio	$V^+ = 1.5V$ , $V^- = -1.3V$ to $-10.25V$	103 108	127		dB dB
	Supply Voltage Range ( $V^+ - V^-$ ) (Note 7)		2.8		11.75	V
$V_{OL}$	Output Swing Low ( $V_{OUT} - V_{EE}$ )	No Load		19	21 26	mV mV
		$I_{SINK} = 5mA$		100	45 120	mV mV
		$I_{SINK} = 25mA$		330	427 670	mV mV
$V_{OH}$	Output Swing High ( $V_{CC} - V_{OUT}$ )	No Load		14	20 26	mV mV
		$I_{SINK} = 5mA$		140	180 200	mV mV
		$I_{SOURCE} = 25mA$		600	1000 1370	mV mV
$I_{SC}$	Output Short-Circuit Current	Sourcing		-64	-42 -35	mA mA
		Sinking	45 32	60		mA mA
$I_S$	Supply Current per Channel			5.5	5.8 7.4	mA mA
$I_{SD}$	Disable Supply Current Per Channel, Amplifier Off	$V_{SHDN} = V^+ - 2.75V$		350	450 520	$\mu A$ $\mu A$
$V_{L\_SHDN}$	$\overline{SHDN}$ Pin Input Voltage Low, Disable Amplifier				$V^+ - 2.75$	V
$V_{H\_SHDN}$	$\overline{SHDN}$ Pin Input Voltage High, Enable Amplifier		$V^+ - 1.6$			V
$I_{L\_SHDN}$	$\overline{SHDN}$ Pin Input Current, Disable Amplifier	$V_{SHDN} = V^+ - 2.75V$	-10	-2.5	10	$\mu A$
$I_{H\_SHDN}$	$\overline{SHDN}$ Pin Input Current, Enable Amplifier	$V_{SHDN} = V^+ - 1.6V$	-10	-0.3	10	$\mu A$
$I_{OSD}$	Output Leakage Current in Shutdown			100		nA
BW	-3dB Closed Loop Bandwidth	$A_V = 1$ , $R_L = 1k\Omega$ to Half Supply		330		MHz
GBW	Gain-Bandwidth Product	$f = 5MHz$ , $R_L = 1k\Omega$ to Half Supply	350 300	420		MHz MHz
$t_{ON}$	Turn-On Time	$V_{SHDN} = V^+ - 2.75V$ to $V^+ - 1.6V$		2100		ns
$t_{OFF}$	Turn-Off Time	$V_{SHDN} = V^+ - 1.6V$ to $V^+ - 2.75V$		800		ns
$t_{S\_0.1}$	Settling Time to 0.1%	$A_V = 1$ , 2V Output Step, $R_L = 1k\Omega$		58		ns
		$A_V = 1$ , 4V Output Step, $R_L = 1k\Omega$		61		ns
$t_{S\_0.01}$	Settling Time to 0.01%	$A_V = 1$ , 6V Output Step, $R_L = 1k\Omega$		150		ns

## ELECTRICAL CHARACTERISTICS ( $V_S = \pm 5V$ )

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ C$ .  $V_S = \pm 5V$ ,  $V_{CM} = 0V$ ,  $V_{SHDN} = \text{floating}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SR	Slew Rate	$A_V = +4$ , 8V Output Step (Note 9)	● 115 90	180		V/ $\mu$ S V/ $\mu$ S
FPBW	Full Power Bandwidth	$V_{OUT} = 8V_{P-P}$ , $A_V = +2$ , THD < -40dBc		5.5		MHz
HD2/HD3	Harmonic Distortion, $R_L = 1k\Omega$ to Half Supply, $A_V = +1$	$f_C = 100kHz$ , $V_O = 4V_{P-P}$		-128/-136		dBc
		$f_C = 1MHz$ , $V_O = 4V_{P-P}$		-99/-91		dBc
	Harmonic Distortion, $R_L = 100\Omega$ to Half Supply, $A_V = +1$	$f_C = 1MHz$ , $V_O = 2V_{P-P}$		-104/-95		dBc
		$f_C = 2MHz$ , $V_O = 4V_{P-P}$		-89/-79		dBc
		$f_C = 2MHz$ , $V_O = 2V_{P-P}$		-91/-80		dBc
		$f_C = 100kHz$ , $V_O = 4V_{P-P}$		-111/-123		dBc
		$f_C = 1MHz$ , $V_O = 4V_{P-P}$		-93/-77		dBc
		$f_C = 1MHz$ , $V_O = 2V_{P-P}$		-96/-80		dBc
$\Delta G$	Differential Gain	$A_V = 2$ , $R_L = 150\Omega$		0.4		%
		$A_V = +1$ , $R_L = 1k\Omega$		0.08		%
$\Delta\theta$	Differential Phase	$A_V = 2$ , $R_L = 150\Omega$		0.025		Deg
		$A_V = +1$ , $R_L = 1k\Omega$		0.13		Deg

## ELECTRICAL CHARACTERISTICS ( $V_S = 5V, 0V$ )

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ C$ .  $V_S = 5V, 0V$ ,  $V_{CM} = V_{OUT} = 2.5V$ ,  $V_{SHDN} = \text{floating}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$V_{OS}$	Input Offset Voltage		● -100 -235	20	100 235	$\mu$ V $\mu$ V
$\Delta V_{OS}$	Input Offset Voltage Match (Channel to Channel, LTC6227, Note 5)		● -140 -400	18	140 400	$\mu$ V $\mu$ V
$T_{CVOS}$	Input Offset Voltage Drift		●	0.4		$\mu$ V/ $^\circ C$
$I_B$	Input Bias Current (Note 5)		● -20 -25	-8.4		$\mu$ A $\mu$ A
$\Delta I_B$	Input Bias Current Match (Channel to Channel, LTC6227, Note 5)		● -2 -3	0.3	2 3	$\mu$ A $\mu$ A
$I_{OS}$	Input Offset Current		-0.35 -0.5	0.2	0.35 0.5	$\mu$ A $\mu$ A
$\Delta I_{OS}$	Input Offset Current Match (Channel to Channel, LTC6227, Note 5)		● -0.7 -1	0.15	0.7 1	$\mu$ A $\mu$ A
$e_n$	Input Noise Voltage Spectral Density	$f = 1MHz$		1		nV/ $\sqrt{Hz}$
	Integrated 1/f Noise	0.1Hz to 10Hz		0.77		$\mu$ V $_{P-P}$
$i_n$	Input Noise Current Spectral Density	$f = 1MHz$		2.4		pA/ $\sqrt{Hz}$
$C_{IN}$	Input Capacitance	Differential Mode		3		pF
		Common Mode		1		pF
$R_{IN}$	Input Resistance	Differential Mode		4.7		k $\Omega$
		Common Mode		6		M $\Omega$
$A_{VOL}$	Large Signal Voltage Gain	$R_L = 1k\Omega$ to Half Supply $V_{OUT} = 0.5V$ to 4.5V	● 114 110	135		dB dB
		$R_L = 100\Omega$ to Half Supply $V_{OUT} = 0.9V$ to 4.1V	● 105 93	120		dB dB
CMRR	Common Mode Rejection Ratio	$V_{CM} = V^- - 0.1V$ to $V^+ - 1.2V$		99	114	dB
				95		dB

**ELECTRICAL CHARACTERISTICS ( $V_S = 5V, 0V$ )** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_S = 5V, 0V, V_{CM} = V_{OUT} = 2.5V, V_{SHDN} = \text{floating}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
$V_{CMR}$	Input Common Mode Range (Note 10)		●	$V^- - 0.1$	$V^+ - 1.2$	V	
$PSRR^+$	Positive Power Supply Rejection Ratio	$V^- = -1V, V^+ = 1.8V \text{ to } 10.75V$	●	100 95		dB dB	
$PSRR^-$	Negative Power Supply Rejection Ratio	$V^+ = 1.5V, V^- = -1.3V \text{ to } -10.25V$	●	103 100		dB dB	
	Supply Voltage Range ( $V^+ - V^-$ ) (Note 7)		●	2.8	11.75	V	
$V_{OL}$	Output Swing Low ( $V_{OUT} - V_{EE}$ )	No Load	●		16 21 23	mV mV	
		$I_{SINK} = 5mA$	●		90 110 155	mV mV	
		$I_{SINK} = 15mA$	●		220 270 370	mV mV	
$V_{OH}$	Output Swing High ( $V_{CC} - V_{OUT}$ )	No Load	●		11 15 20	mV mV	
		$I_{SINK} = 5mA$	●		150 180 200	mV mV	
		$I_{SOURCE} = 15mA$	●		331 500 650	mV mV	
$I_{SC}$	Output Short-Circuit Current	Sourcing	●		-52 -34 -30	mA mA	
		Sinking	●	42 30	57	mA mA	
$I_S$	Supply Current per Channel		●		5.8 6.3 7.6	mA mA	
$I_{SD}$	Disable Supply Current Per Amplifier, Amplifier Off	$V_{SHDN} = V^+ - 2.65V$	●		245 310 330	$\mu\text{A}$ $\mu\text{A}$	
$V_{L\_SHDN}$	$\overline{SHDN}$ Pin Input Voltage Low, Disable Amplifier		●		$V^+ - 2.65$	V	
$V_{H\_SHDN}$	$\overline{SHDN}$ Pin Input Voltage High, Enable Amplifier		●	$V^+ - 1.6$		V	
$I_{L\_SHDN}$	$\overline{SHDN}$ Pin Input Current, Disable Amplifier	$V_{SHDN} = V^+ - 2.65V$	●	-10	-2.9	10	$\mu\text{A}$
$I_{H\_SHDN}$	$\overline{SHDN}$ Pin Input Current, Enable Amplifier	$V_{SHDN} = V^+ - 1.6V$	●	-10	-0.3	10	$\mu\text{A}$
$I_{OSD}$	Output Leakage Current in Shutdown				100	nA	
BW	-3dB Closed Loop Bandwidth	$A_V = 1, R_L = 1k\Omega \text{ to Half Supply}$			490	MHz	
GBW	Gain-Bandwidth Product	$f = 5MHz, R_L = 1k\Omega \text{ to Half Supply}$	●	350 290	430	MHz MHz	
$t_{ON}$	Turn-On Time	$V_{SHDN} = V^+ - 2.65V \text{ to } V^+ - 1.6V$			2100	ns	
$t_{OFF}$	Turn-Off Time	$V_{SHDN} = V^+ - 1.6V \text{ to } V^+ - 2.65V$			800	ns	
$t_{S\_0.1}$	Settling Time to 0.1%	$A_V = 1, 2V \text{ Output Step}, R_L = 1k\Omega$			59	ns	

**ELECTRICAL CHARACTERISTICS ( $V_S = 5V, 0V$ )** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_S = 5V, 0V, V_{CM} = V_{OUT} = 2.5V, V_{SHDN} = \text{floating}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SR	Slew Rate	$A_V = +4, 4V$ Output Step (Note 9)		140		V/ $\mu\text{S}$
FPBW	Full Power Bandwidth	$V_{OUT} = 4V_{P-P}, A_V = +2, THD < -40\text{dBc}$		6		MHz
HD2/HD3	Harmonic Distortion, $R_L = 1\text{k}\Omega$ to Half Supply	$f_C = 100\text{kHz}, V_O = 2V_{P-P}$		-125/-135		dBc
		$f_C = 1\text{MHz}, V_O = 2V_{P-P}$		-104/-106		dBc
		$f_C = 2\text{MHz}, V_O = 2V_{P-P}$		-90/-90		dBc
	Harmonic Distortion, $R_L = 100\Omega$ to Half Supply	$f_C = 100\text{kHz}, V_O = 2V_{P-P}$		-112/-128		dBc
		$f_C = 1\text{MHz}, V_O = 2V_{P-P}$		-96/-88		dBc
		$f_C = 2\text{MHz}, V_O = 2V_{P-P}$		-88/-74		dBc
$\Delta G$	Differential Gain	$A_V = 2, R_L = 150\Omega$		0.17		%
		$A_V = +1, R_L = 1\text{k}\Omega$		0.09		%
$\Delta\theta$	Differential Phase	$A_V = 2, R_L = 150\Omega$		0.3		Deg
		$A_V = +1, R_L = 1\text{k}\Omega$		0.04		Deg

**ELECTRICAL CHARACTERISTICS ( $V_S = 3V, 0V$ )** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_S = 3V, 0V, V_{CM} = 1.5V, V_{SHDN} = \text{floating}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
$V_{OS}$	Input Offset Voltage			-110	24	110	$\mu\text{V}$
			●	-250		250	$\mu\text{V}$
$\Delta V_{OS}$	Input Offset Voltage Match (Channel to Channel, LTC6227, Note 5)			-140	18	140	$\mu\text{V}$
			●	-400		400	$\mu\text{V}$
$T_{CVOS}$	Input Offset Voltage Drift			0.4		$\mu\text{V}/^\circ\text{C}$	
$I_B$	Input Bias Current (Note 6)	Bias Cancellation Disabled		-20	-8.4		$\mu\text{A}$
			●	-26			$\mu\text{A}$
$\Delta I_B$	Input Bias Current Match (Channel to Channel, LTC6227, Note 5)			-2	0.3	2	$\mu\text{A}$
		●		-3		3	$\mu\text{A}$
$I_{OS}$	Input Offset Current			-0.35	0.2	0.35	$\mu\text{A}$
		●		-0.5		0.5	$\mu\text{A}$
$\Delta I_{OS}$	Input Offset Current Match (Channel to Channel, LTC6227, Note 5)			-0.7	0.15	0.7	$\mu\text{A}$
		●		-1		1	$\mu\text{A}$
$e_n$	Input Noise Voltage Spectral Density	$f = 1\text{MHz}$			1	$\text{nV}/\sqrt{\text{Hz}}$	
		Integrated 1/f Noise	0.1Hz to 10Hz		0.77	$\mu\text{V}_{P-P}$	
$i_n$	Input Current Noise Spectral Density	$f = 1\text{MHz}$		2.4		$\text{pA}/\sqrt{\text{Hz}}$	
$C_{IN}$	Input Capacitance	Differential Mode		3		pF	
		Common Mode		1		pF	
$R_{IN}$	Input Resistance	Differential Mode		4.7		$\text{k}\Omega$	
		Common Mode		6		$\text{M}\Omega$	
$A_{VOL}$	Large Signal Voltage Gain	$R_L = 1\text{k}\Omega$ to Half Supply, ( $V_{OUT} = V_{CM} \pm 1V$ )	●	114	135	dB	
		$R_L = 100\Omega$ to Half Supply, ( $V_{OUT} = V_{CM} \pm 1V$ )		100		dB	
				114		dB	
CMRR	Common Mode Rejection Ratio	$V_{CM} = V^- - 0.1V$ to $V^+ - 1.2V$		98	114	dB	
			●	90		dB	
$V_{CMR}$	Input Common Mode Range (Note 10)		●	$V^- - 0.1$	$V^+ - 1.2$	V	
PSRR <sup>+</sup>	Positive Power Supply Rejection Ratio	$V^- = -1V, V^+ = 1.8V$ to $10.75V$		100	115	dB	
			●	95		dB	

## ELECTRICAL CHARACTERISTICS ( $V_S = 3V, 0V$ )

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ C$ .  $V_S = 3V, 0V, V_{CM} = 1.5V, V_{SHDN}$  = floating unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
PSRR <sup>-</sup>	Negative Power Supply Rejection Ratio	$V^+ = 1.5V, V^- = -1.3V$ to $-10.25V$	103	127		dB
			100			dB
	Supply Voltage Range ( $V^+ - V^-$ ) (Note 7)		2.8		11.75	V
$V_{OL}$	Output Swing Low ( $V_{OUT} - V_{EE}$ )	No Load		12	14	mV
					18	mV
		$I_{SINK} = 5mA$		91	121	mV
				160	mV	
		$I_{SINK} = 10mA$		161	205	mV
				275	mV	
$V_{OH}$	Output Swing High ( $V_{CC} - V_{OUT}$ )	No Load		10	14	mV
					18	mV
		$I_{SINK} = 5mA$		150	180	mV
				230	mV	
		$I_{SOURCE} = 10mA$		250	330	mV
				430	mV	
$I_{SC}$	Output Short Circuit Current	Sourcing		47		mA
		Sinking		57		mA
$I_S$	Supply Current/Channel			5.5	6	mA
					7.25	mA
$I_{SD}$	Disable Supply Current, Amplifier Off	$V_{SHDN} = V^+ - 2.65V$		195	247	$\mu A$
					278	$\mu A$
$V_{L\_SHDN}$	$\overline{SHDN}$ Pin Input Voltage Low, Disable Amplifier				$V^+ - 2.65$	V
$V_{H\_SHDN}$	$\overline{SHDN}$ Pin Input Voltage High, Enable Amplifier		$V^+ - 1.6$			V
$I_{L\_SHDN}$	$\overline{SHDN}$ Pin Input Current, Disable Amplifier	$V_{SHDN} = V^+ - 2.65V$	-10	-2.9	10	$\mu A$
$I_{H\_SHDN}$	$\overline{SHDN}$ Pin Input Current, Enable Amplifier	$V_{SHDN} = V^+ - 1.6V$	-10	0.3	10	$\mu A$
$I_{OSD}$	Output Leakage Current in Shutdown			100		nA
BW	-3dB Closed Loop Bandwidth	$A_V = 1, R_L = 1k\Omega$ to Half Supply		450		MHz
GBW	Gain-Bandwidth Product	$f = 5MHz, R_L = 1k\Omega$ to Half Supply	340	415		MHz
			280			MHz
$t_{ON}$	Turn-On Time	$V_{SHDN} = V^+ - 2.65V$ to $V^+ - 1.6V$		2100		ns
$t_{OFF}$	Turn-Off Time	$V_{SHDN} = V^+ - 1.6V$ to $V^+ - 2.65V$		800		ns
$t_{S\_0.1}$	Settling Time to 0.1%	$A_V = 1, V_{CM} = 1V, 1V$ Output Step, $R_L = 1k\Omega$ to $V_{CM}$		84		ns
SR	Slew Rate (Note 9)	$A_V = +4, 2V$ Output Step		100		V/ $\mu S$
FPBW	Full Power Bandwidth	$V_{OUT} = 2V_{P-P}, A_V = -1, THD < -40dBc$		8		MHz



**ELECTRICAL CHARACTERISTICS ( $V_S = 3V, 0V$ )** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ C$ .  $V_S = 3V, 0V, V_{CM} = 1.5V, V_{SHDN} = \text{floating}$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
HD2/HD3	Harmonic Distortion, $R_L = 1k\Omega$ to $V_{CM}$ , $V_{OUT} = 1V_{P-P}, V_{CM} = 1V$	$f_C = 100kHz$		-122/-137		dBc
		$f_C = 1MHz$		-108/-111		dBc
		$f_C = 2MHz$		-95/-95		dBc
	Harmonic Distortion, $R_L = 100\Omega$ to $V_{CM}$ , $V_{OUT} = 1V_{P-P}, V_{CM} = 1V$	$f_C = 100kHz$		-113/-130		dBc
		$f_C = 1MHz$		-100/-94		dBc
		$f_C = 2MHz$		-90/-79		dBc

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** The inputs are protected by back-to-back diodes. If any of the input or shutdown pins goes 300mV beyond either supply or the differential input voltage exceeds 0.7V, the input current should be limited to less than 10mA.

**Note 3:** A heat sink may be required to keep the junction temperature below the absolute maximum rating when the output current is high.

**Note 4:** The LTC6226I/LTC6227I are guaranteed functional and specified over the temperature range of  $-40^\circ C$  to  $85^\circ C$ . The LTC6226H/LTC6227H are guaranteed and specified functional over the temperature range of  $-40^\circ C$  to  $125^\circ C$ .

**Note 5:** Matching parameters are the difference between amplifiers A and B on the LTC6227.

**Note 6:** The input bias current is the average of the average of the currents through the positive and negative input pins.

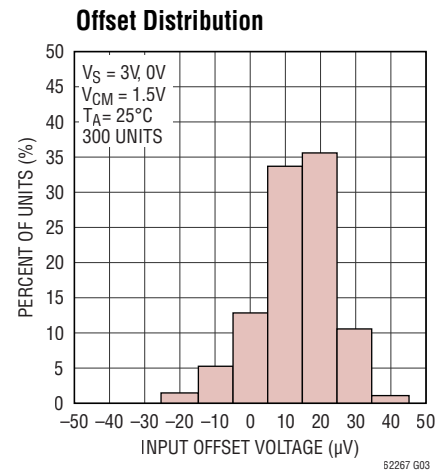
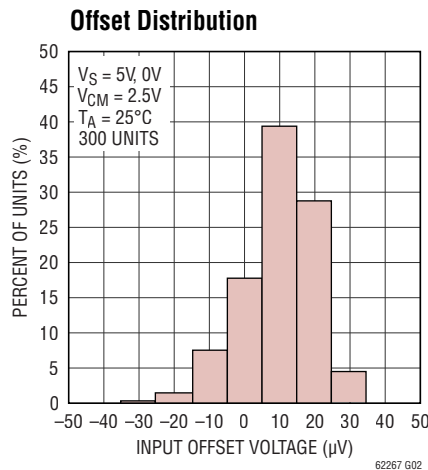
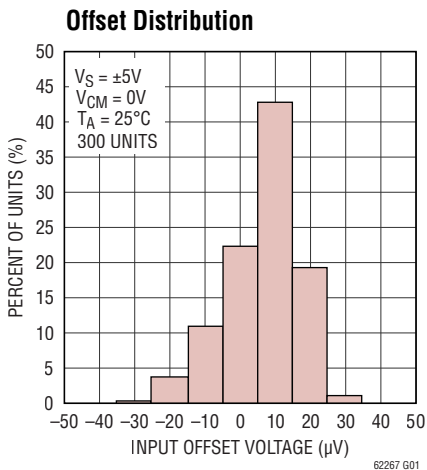
**Note 7:** Supply Voltage Range is guaranteed by Power Supply Rejection Ratio test.

**Note 8:** Thermal resistance varies with the amount of PC board metal connected to the package. The specified values are with short traces connected to the leads.

**Note 9:** Middle 2/3 of the output waveform is observed for Slew Rate.  $R_L = 1k$  to half supply.

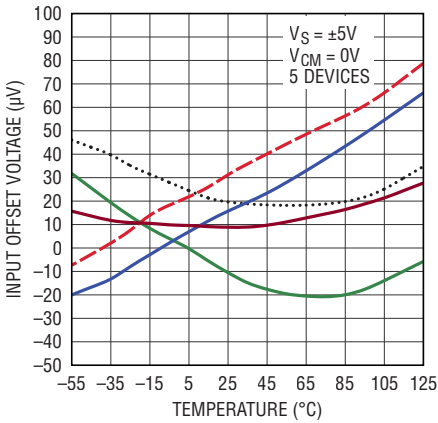
**Note 10:** Input Common Mode Range is guaranteed by Common Mode Rejection Ratio Test.

**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_S = \pm 5V, V_{CM} = 0V, R_L = 1k\Omega$  to Half Supply,  $T_A = 25^\circ C$ , unless otherwise noted.



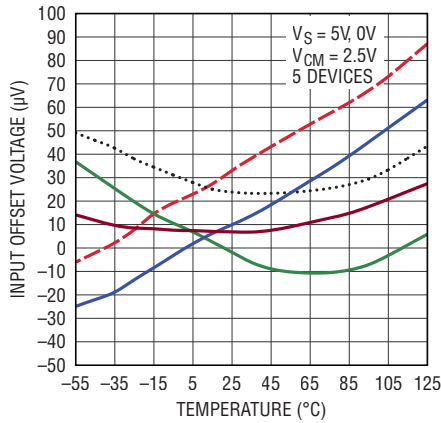
**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_S = \pm 5V$ ,  $V_{CM} = 0V$ ,  $R_L = 1k\Omega$  to Half Supply,  $T_A = 25^\circ C$ , unless otherwise noted.

**$V_{OS}$  vs Temperature, 10V Supply**



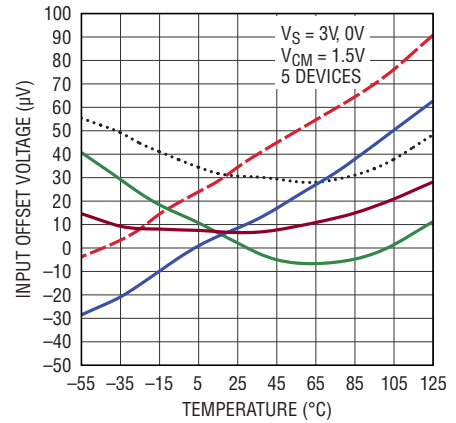
62267 G04

**$V_{OS}$  vs Temperature, 5V Supply**



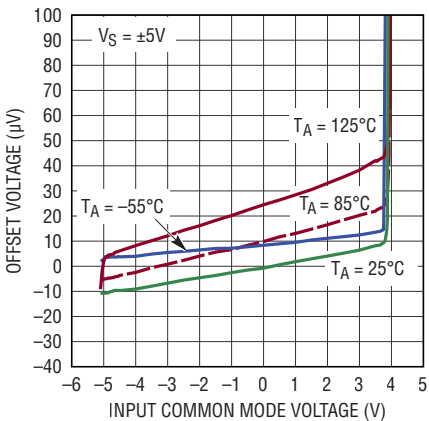
6227 G05

**$V_{OS}$  vs Temperature, 3V Supply**



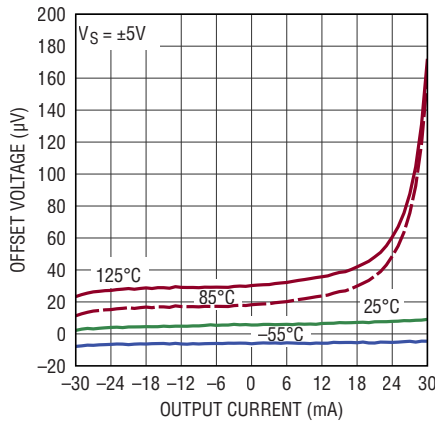
62267 G06

**Offset Voltage vs Input Common Mode Voltage**



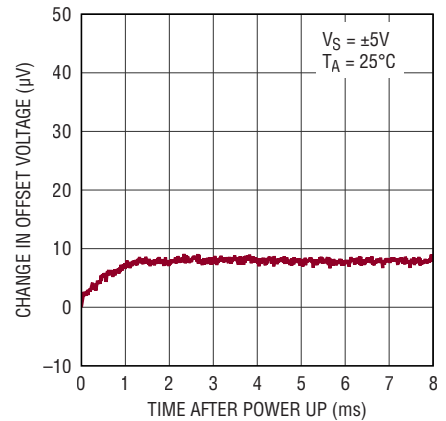
62267 G07

**Offset Voltage vs Output Current**



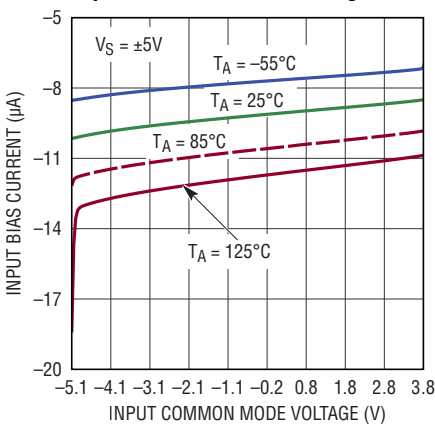
62267 G08

**Warm Up Drift vs Time**



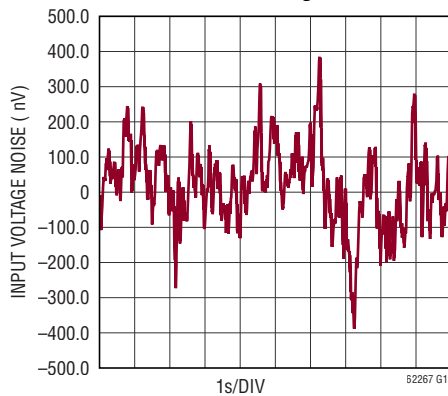
62267 G09

**Input Bias Current vs Input Common Mode Voltage**



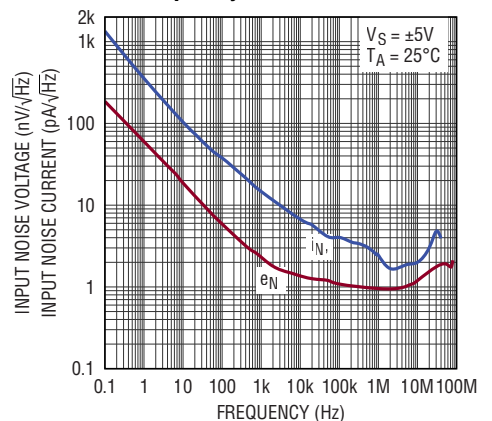
62267 G10

**0.1Hz to 10Hz Voltage Noise**



62267 G11

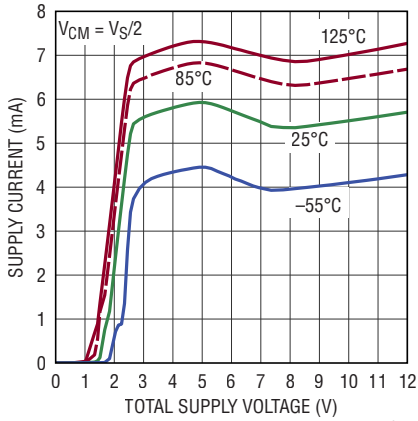
**Input Noise Voltage and Noise Current Spectral Densities vs Frequency**



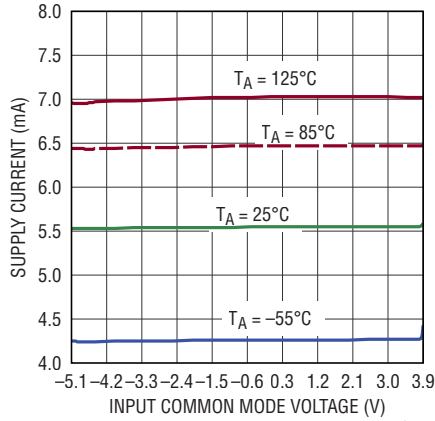
62267 G12

**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_S = \pm 5V$ ,  $V_{CM} = 0V$ ,  $R_L = 1k\Omega$  to Half Supply,  $T_A = 25^\circ C$ , unless otherwise noted.

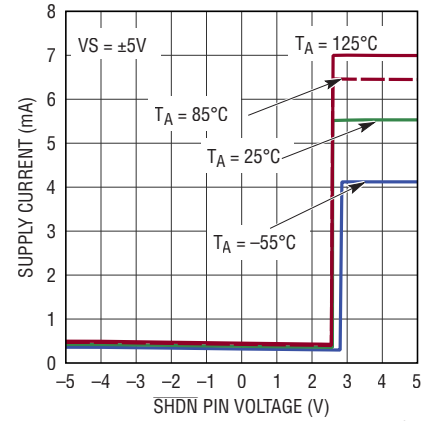
**Supply Current vs Supply Voltage**



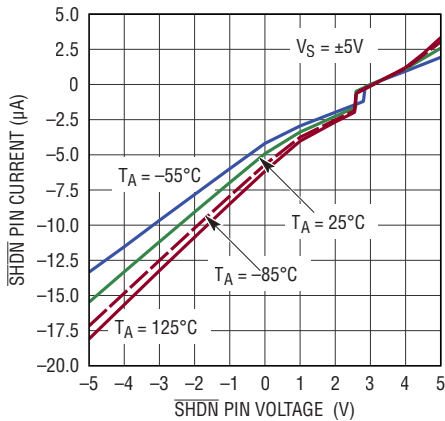
**Supply Current vs Input Common Mode Voltage**



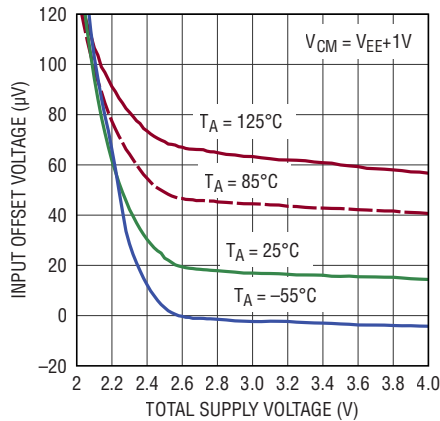
**Supply Current vs SHDN Pin Voltage**



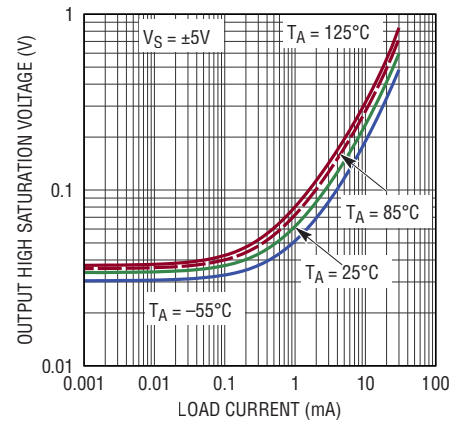
**SHDN Pin Current vs SHDN Pin Voltage**



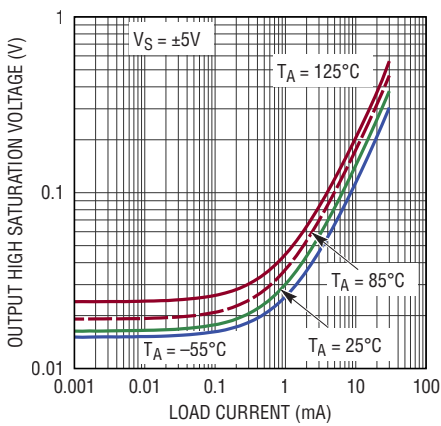
**Minimum Supply Voltage**



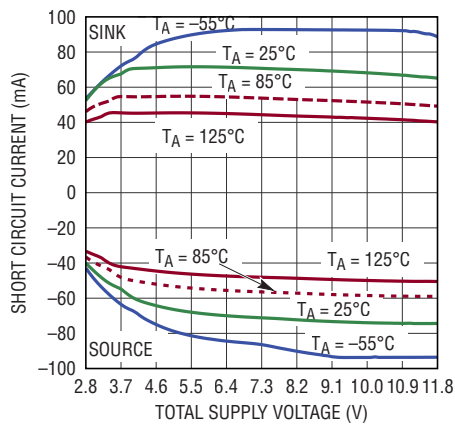
**Output Saturation Voltage vs Load Current (Output High)**



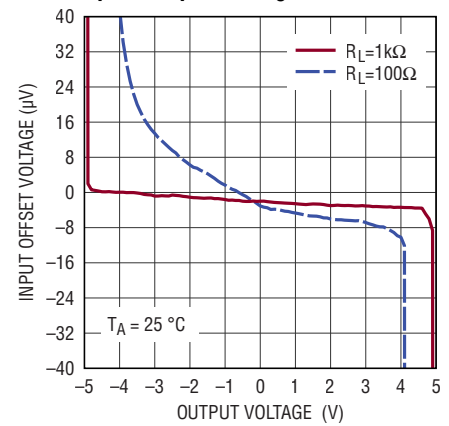
**Output Saturation Voltage vs Load Current (Output Low)**



**Output Short Circuit Current vs Supply Voltage**

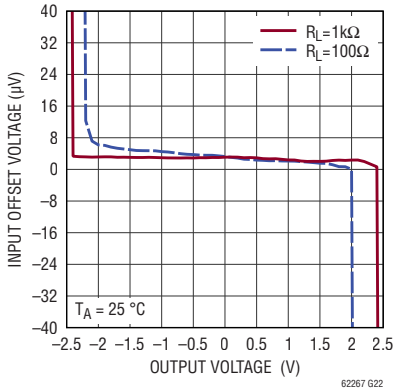


**Open Loop Gain,  $V_S = \pm 5V$**

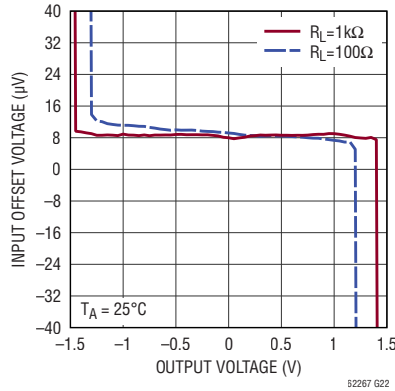


## TYPICAL PERFORMANCE CHARACTERISTICS $V_S = \pm 5V$ , $V_{CM} = 0V$ , $R_L = 1k\Omega$ to Half Supply, $T_A = 25^\circ C$ , unless otherwise noted.

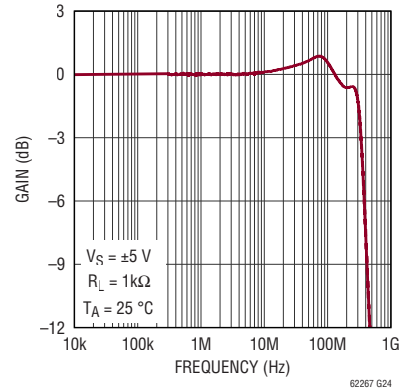
**Open Loop Gain,  $V_S = \pm 2.5V$**



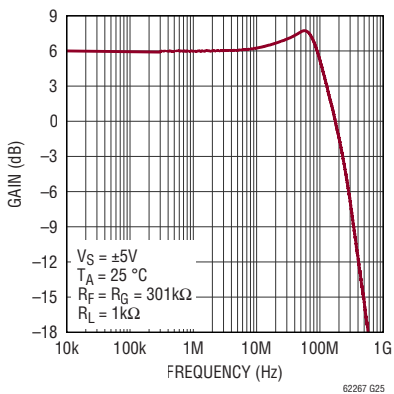
**Open Loop Gain,  $V_S = \pm 1.5V$**



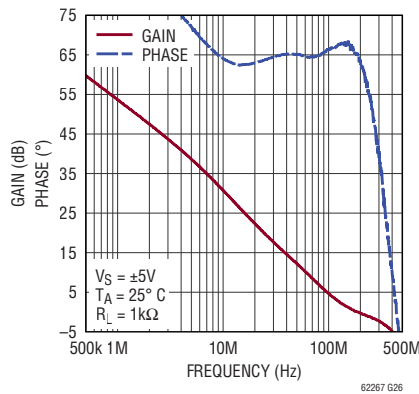
**Gain vs Frequency  $A_V = 1$**



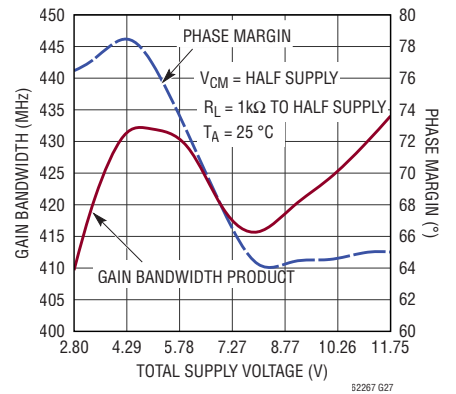
**Gain vs Frequency  $A_V = 2$**



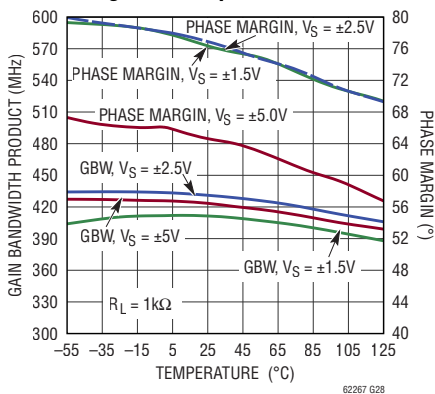
**Open Loop Gain and Phase vs Frequency**



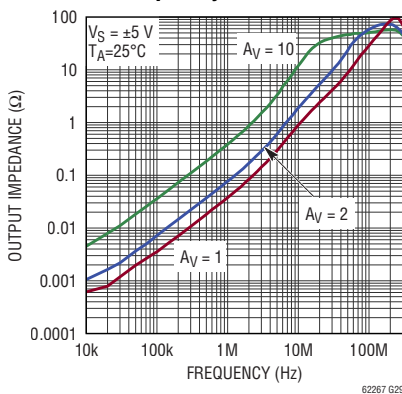
**Gain Bandwidth and Phase Margin vs Supply Voltage**



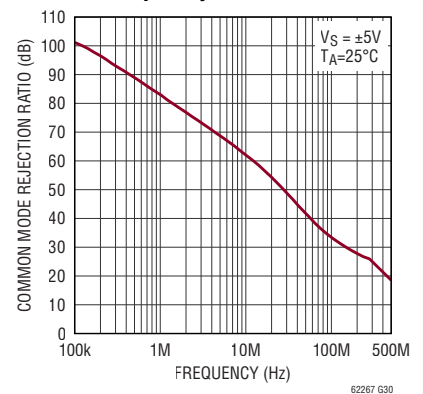
**Gain Bandwidth and Phase Margin vs Temperature**



**Output Impedance vs Frequency**

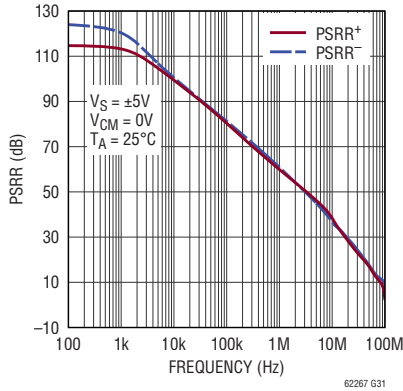


**Common Mode Rejection Ratio vs Frequency**

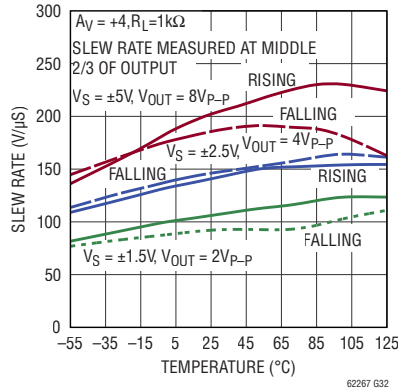


**TYPICAL PERFORMANCE CHARACTERISTICS**  $V_S = \pm 5V$ ,  $V_{CM} = 0V$ ,  $R_L = 1k\Omega$  to Half Supply,  $T_A = 25^\circ C$ , unless otherwise noted.

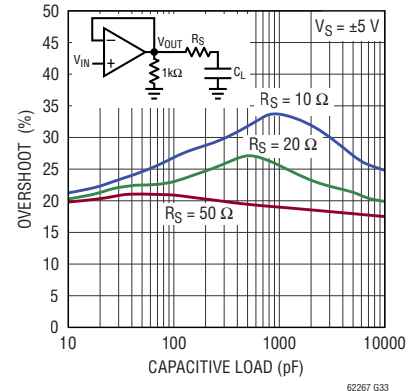
**Power Supply Rejection Ratio vs Frequency**



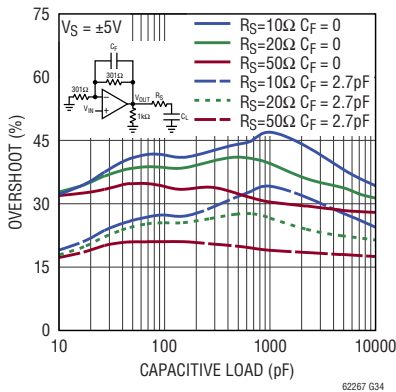
**Slew Rate vs Temperature**



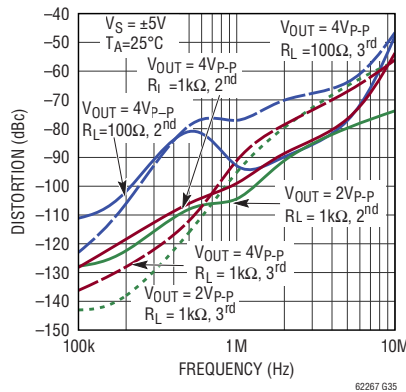
**Overshoot vs Capacitive Load ( $A_V = +1$ )**



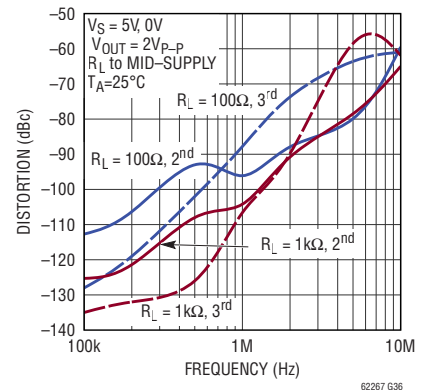
**Overshoot vs Capacitive Load ( $A_V = +2$ )**



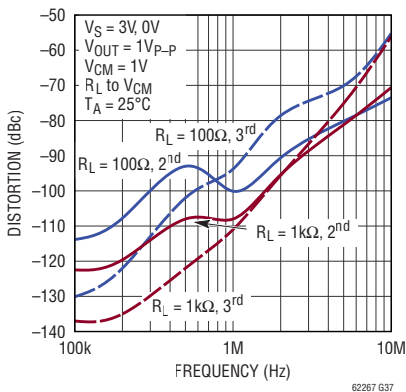
**Distortion vs Frequency,  $A_V = 1$ , ±5V Supply**



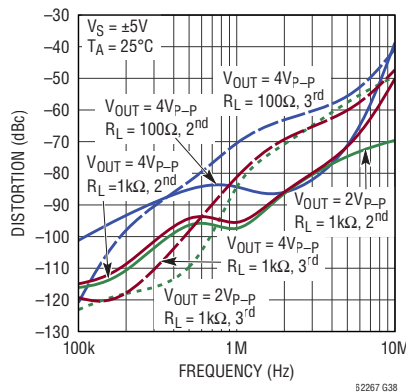
**Distortion vs Frequency,  $A_V = 1$ , 5V Supply**



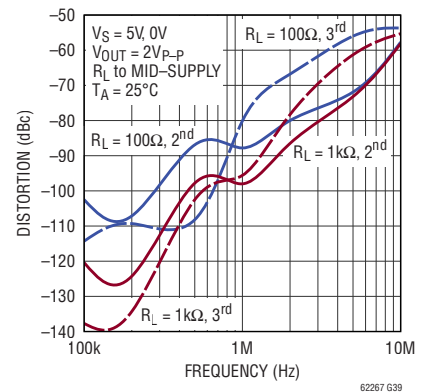
**Distortion vs Frequency,  $A_V = 1$ , 3V Supply**



**Distortion vs Frequency,  $A_V = 2$ , ±5V Supply**

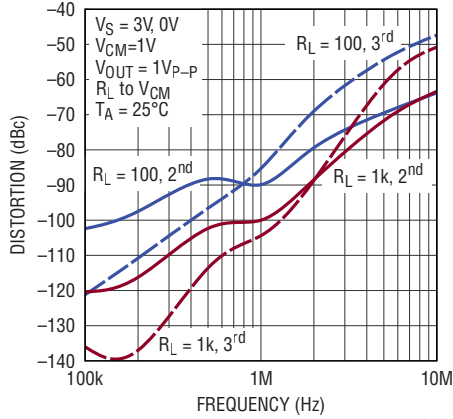


**Distortion vs Frequency,  $A_V = 2$ , 5V Supply**



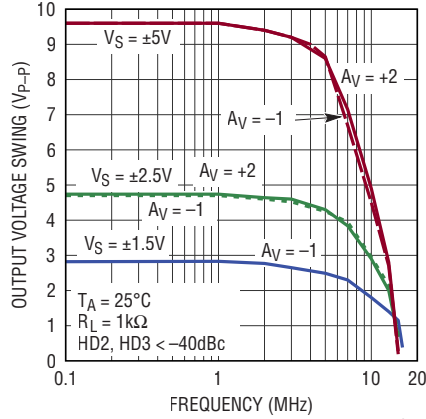
## TYPICAL PERFORMANCE CHARACTERISTICS $V_S = \pm 5V$ , $V_{CM} = 0V$ , $R_L = 1k\Omega$ to Half Supply, $T_A = 25^\circ C$ , unless otherwise noted.

**Distortion vs Frequency,  $A_V = 2$ , 3V Supply**



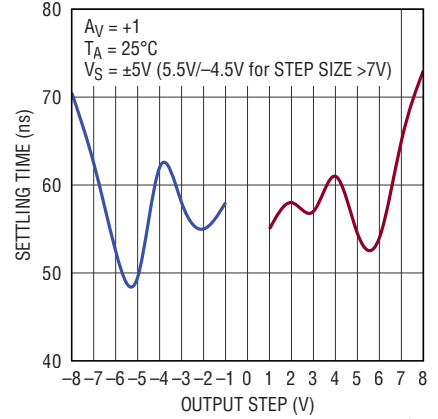
62267 G40

**Maxium Undistorted Output Signal vs Frequency**



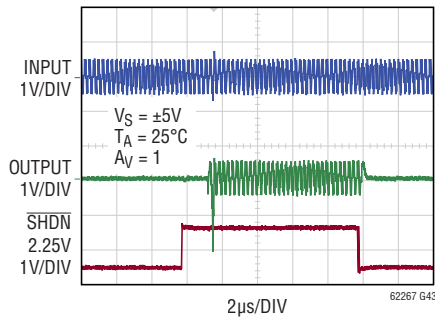
62267 G41

**0.1% Settling Time vs Output Step**



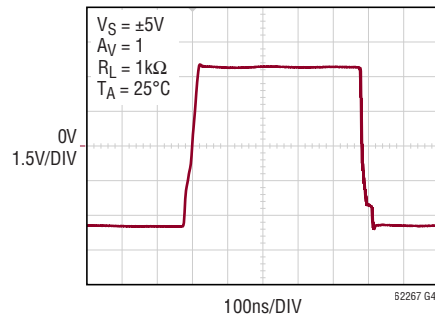
62267 G42

**SHDN Pin Response Time**



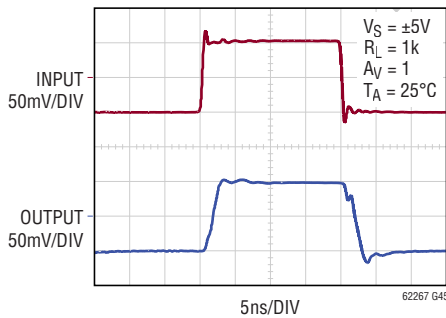
62267 G43

**Large Signal Response**



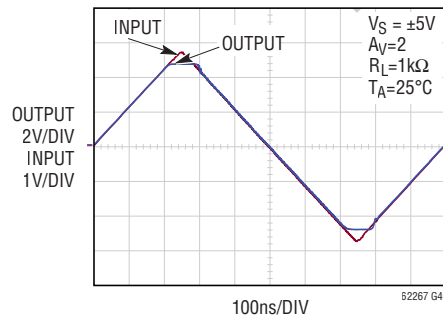
62267 G44

**Small Signal Response**



62267 G45

**Output Overdriven Recovery**



62267 G46

## PIN FUNCTIONS

**FB (SOIC-8 Only):** Feedback Pin. Internally connected to OUT.

**+IN:** Non-Inverting Input of Amplifier. Valid input range is from  $V^-$  to  $V^+ - 1.2V$

**-IN:** Inverting Input of Amplifier. Valid input range is from  $V^-$  to  $V^+ - 1.2V$

**OUT:** Output of the Amplifier. Swings rail to rail and can typically source/sink 60mA of current.

**SHDN:** Shutdown Pin (Active Low). Referenced to  $V^+$ . When taken 2.75V below  $V^+$ , the amplifier shuts down and enters low power mode, with the outputs in a high impedance state. When left floating, the amplifier is on.

**$V^+$ :** Positive Supply to Amplifier. Valid range is from 2.8V to 11.75V when  $V^-$  is 0V.

**$V^-$ :** Negative Supply to Amplifier. Typically 0V. This can be made a negative voltage as long as  $2.8V \leq (V^+ - V^-) \leq 11.75V$

## APPLICATIONS INFORMATION

### Circuit Description

The LTC6226/LTC6227 have an input signal range that extends from the negative power supply to 1.2V below the positive power supply. Figure 1 depicts a simplified schematic of the amplifier. The input stage consists of PNP transistors Q1 and Q2. Bootstrap transistor Q13 improves DC accuracy by reducing the offset contribution of the base currents of Q11 and Q12 since it has twice their collector current thus Q11/Q12 current matching becomes

independent of transistor  $\beta$ . The bootstrap arrangement also enhances gain by improving output impedance. A pair of complementary common emitter stages, Q15 and Q14, enables the output to swing to either rail. The SHDN Interface block translates the SHDN signal into pwr\_dn for powering down the device (by deactivating current sources I1 - I4) and putting the output in a high impedance state (by shorting the bases of Q15/Q14 to the supplies via M2 and M1).

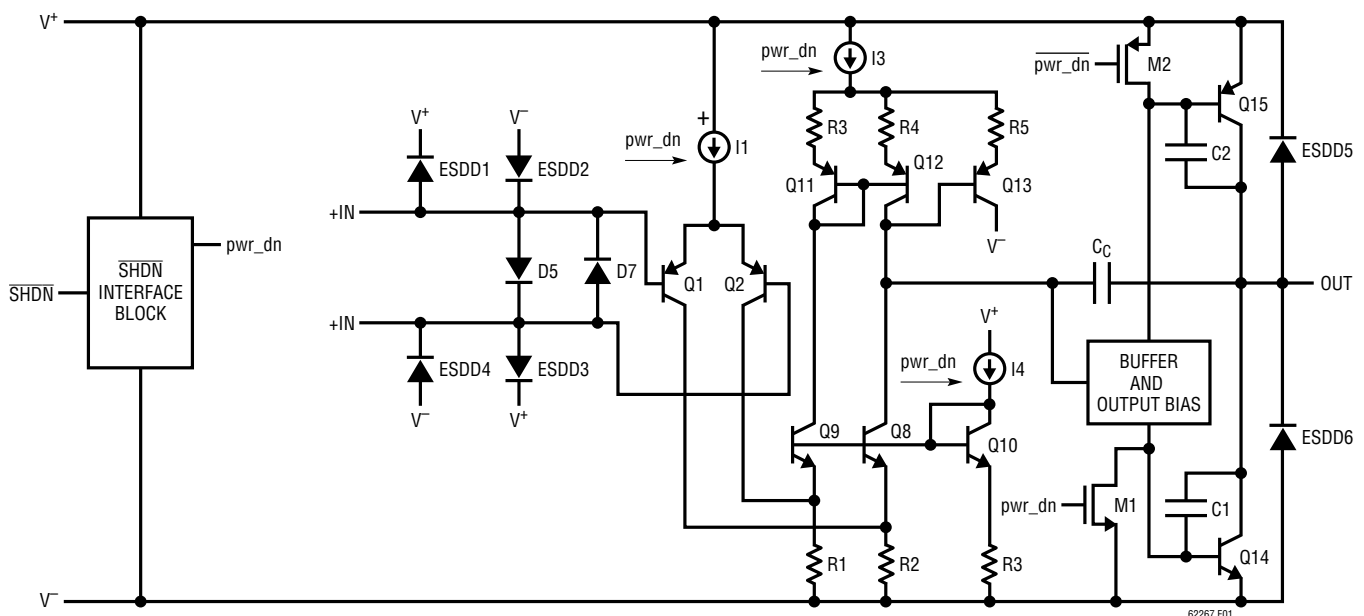


Figure 1. LTC6226/LTC6227 Simplified Schematic Diagram



## APPLICATIONS INFORMATION

### Output

The LTC6226 family has excellent output drive capability. The amplifiers can typically deliver more than 50mA of output drive current at a total supply of 10V, and can typically swing to within 600mV of the rail for load currents as high as 25mA. As the supply voltage to the amplifier decreases, the output current capability also decreases. Attention must be paid to keep the junction temperature of the IC below 150°C (refer to power dissipation section) when the output is in continuous short-circuit. The output of the amplifier has reverse-biased diodes connected to each supply. If the output is forced beyond either supply, extremely high currents will flow through those diodes which can result in damage to the device. Forcing the output to even 1V beyond either supply could result in several hundred milliamps of current through either diode. Thus forcing the output beyond the supplies should be avoided.

### Input Protection

The LTC6226/LTC6227 has a pair of back to back diodes (D5 and D7) to prevent the emitter base breakdown of the input transistors and limit the differential input to  $\pm 700\text{mV}$ . Unlike many other high performance amplifiers, the bases of the input pair transistors Q1 and Q2 are not connected to the pins using internal resistors to limit input current, since that would cause the noise to increase. For instance, a  $100\Omega$  resistor in series with each input would generate  $1.8\text{nV}/\sqrt{\text{Hz}}$  of noise, and the total amplifier noise voltage would rise from  $1\text{nV}/\sqrt{\text{Hz}}$  to  $2.06\text{nV}/\sqrt{\text{Hz}}$ . Once the input differential voltage exceeds  $\pm 0.7\text{V}$ , current conducted through the protection diodes should be limited to  $\pm 10\text{mA}$ . This implies  $25\Omega$  of protection resistance per quarter volt (250mV) of overdrive beyond  $\pm 0.7\text{V}$ . In addition, the input and shutdown pins have reverse biased diodes connected to the supplies. The current in these diodes must be limited to less than 10mA. The amplifiers should not be used as comparators or in other open loop applications.

### ESD

The LTC6226 family has reverse biased ESD protection diodes on all inputs as shown in Figure 1. There is an additional clamp between the positive and negative supplies that further protects the device during ESD strikes.

Hot plugging of the device into a powered socket must be avoided since this can trigger the clamp resulting in larger currents flowing between the supply pins.

### Capacitive Loads

The LTC6226/LTC6227 are optimized for high bandwidth applications, and have not been designed to directly drive capacitive loads. Hence any trace capacitance at the output should be made as small as possible. Increased capacitance at the output creates an additional pole in the open loop frequency response, worsening the phase margin. When driving capacitive loads, a resistor of  $10\Omega$  to  $100\Omega$  should be connected between the amplifier output and the capacitive load to avoid ringing or oscillation. The feedback should be taken directly from the amplifier output. Higher voltage gain configurations tend to have better capacitive drive capability than lower gain configurations due to lower closed loop bandwidth and hence higher phase margin. The graphs titled Overshoot vs Capacitive Load demonstrate the transient response of the amplifier when driving capacitive loads with various series resistors.



## APPLICATIONS INFORMATION

### Feedback Components

When feedback resistors are used to set up gain, care must be taken to ensure that the pole formed by the feedback resistors and the parasitic capacitance at the inverting input does not degrade stability. For example if the amplifier is set up in a gain of +2 configuration with gain and feedback resistors of 1k, a parasitic capacitance of 7pF (device + PC board) at the amplifier's inverting input will cause the part to oscillate, due to a pole formed at 45MHz. An additional capacitor of 7pF across the feedback resistor as shown in Figure 2 will eliminate any ringing or oscillation. In general, if the resistive feedback network results in a pole whose frequency lies within the closed loop bandwidth of the amplifier, a capacitor can be added in parallel with the feedback resistor to introduce a zero whose frequency is close to the frequency of the pole, improving stability. For high speed designs, minimizing parasitic inductance is important. The use of capacitors where the electrodes are terminated on the long side instead of the short side (for example the use of 0306 instead of 0603 components) can help in this regard.

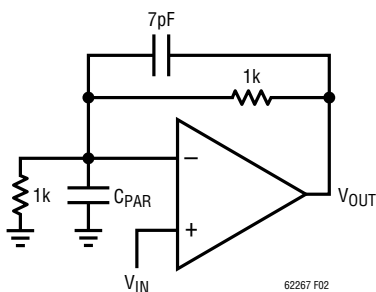


Figure 2. 7pF Feedback Cancels Parasitic Pole

### Shutdown

The LTC6226 and LTC6227DD have  $\overline{\text{SHDN}}$  pins that can shut down the amplifier to 350 $\mu$ A typical supply current. The  $\overline{\text{SHDN}}$  pin needs to be taken 2.75V below the positive supply to shut down. When left floating, the  $\overline{\text{SHDN}}$  pin is internally pulled up to 1.2V below the positive supply and the amplifier remains on. During shutdown, the output transistors Q15 and Q14 in Figure 1 are in a high impedance state.

### Power Dissipation

Care must be taken to ensure that the junction temperature of the die does not exceed 150°C.

The junction temperature,  $T_J$ , is calculated from the ambient temperature,  $T_A$ , power dissipation,  $P_D$ , and thermal resistance,  $\theta_{JA}$ :

$$T_J = T_A + (P_D \cdot \theta_{JA}).$$

The power dissipation in the IC is a function of the supply voltage, output voltage and load resistance. For symmetric supply voltages with output load connected to ground, the worst-case power dissipation  $P_{D(\text{MAX})}$  occurs when the supply current is maximum and the output voltage at half of either supply voltage for a given load resistance.  $P_{D(\text{MAX})}$  is approximately (since  $I_S$  actually changes with output load current) given by:

$$P_{D(\text{MAX})} = (2 \cdot V_S \cdot I_{S(\text{MAX})}) + (V_S/2)^2/R_L$$

Example: For an LTC6227 in a 8-lead MS package operating on  $\pm 5V$  supplies and driving a 250 $\Omega$  load to ground, the worst-case power dissipation is approximately given by  $P_{D(\text{MAX})}/\text{Amp} = (10 \cdot 7.4\text{mA}) + (5/2)^2/250 = 99\text{mW}$ . If both channels are loaded identically, the total power dissipation is 198mW.

At the Absolute Maximum ambient operating temperature, the junction temperature under these conditions will be:

$$T_J = T_A + (P_D \cdot \theta_{JA}) = 125 + 0.198 \cdot 35 = 132^\circ\text{C}$$

which is less than the absolute maximum junction temperature for the LTC6227.

Refer to the Pin Configuration section for thermal resistances of various packages

### Board Layout and Bypass Capacitors

High speed and RF board layout techniques should be applied due to the very high speeds of the signals involved. For the LTC6226 SOIC-8 package option, the feedback should be taken from the FB pin rather than from the output pin, to reduce signal trace length.

Stray capacitances at the  $-IN$  and  $+IN$  pins should be made as low as possible to reduce stability degradation.

## APPLICATIONS INFORMATION

For single supply applications, it is recommended that high quality 0.1 $\mu$ F||1000pF ceramic bypass capacitors be placed directly between each V<sup>+</sup> pin and its closest V<sup>-</sup> pin with short connections. The V<sup>-</sup> pins (including the Exposed Pad) should be tied directly to a low impedance ground plane with minimal routing. For dual (split) power supplies, it is recommended that additional high quality 0.1 $\mu$ F||1000pF ceramic capacitors be used to bypass V<sup>+</sup> pins to ground and V<sup>-</sup> pins to ground, again with minimal routing.

### Noise Considerations

The ultralow input referred voltage noise of 1nV/ $\sqrt{\text{Hz}}$  is equivalent to that of an 60 $\Omega$  resistor. As with all BJT input amplifiers, lowering input referred noise is achieved by increasing the collector current of the input differential pair, which increases the input referred current noise.

Figure 3 shows the LTC6226 in a typical gain configuration.

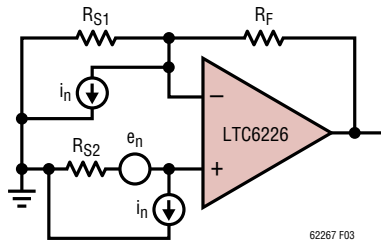


Figure 3.

As can be seen, the input referred noise spectral density of the gain stage ( $e_T$ ) can be calculated by the following equations:

$$e_T^2 = e_n^2 + i_n^2 R_{EQ}^2 + 4kTR_{EQ}$$

Where

$R_{EQ} = R_{S2} + R_{S1} || R_F$ ,  $k$  is the Boltzmann constant and  $T$  is the temperature (in Kelvin).

Op amp input referred noise dominates the input referred noise of the gain stage when

$$R_{EQ} \ll e_n^2 / 4kT$$

Resistor noise dominated the input referred noise of the gain stage when

$$R_{EQ} \gg e_n^2 / 4kT \text{ and } R_{EQ} \ll 4kT / i_n^2$$

Op amp input referred current noise dominates the input referred noise when

$$R_{EQ} \gg 4kT / i_n^2$$

With an input referred voltage noise spectral density of 1nV/Hz and an input referred current noise of 2.4pA/Hz, it is easy to see that the gain stage's input referred noise is dominated by op amp voltage noise when  $R_{EQ} \ll 60\Omega$  and by resistor noise when

$$60\Omega \ll R_{EQ} \ll 2.9k\Omega.$$

Above an  $R_{EQ}$  of 2.9k $\Omega$ , input referred current noise dominates.

### Distortion/Noise Trade-Off

As evident from the previous section, gain stage noise can be reduced by reducing  $R_{EQ}$ . However, reducing  $R_{EQ}$  has its disadvantages. In addition to increasing power dissipation in the presence of large output signals, the use of smaller resistors for a given gain results in increased distortion, because the internal nonlinearities of the op amp worsen with increasing load current. In addition, smaller resistors decrease op amp gain and hence can affect bandwidth. Hence when designing a system using the LTC6226/LTC6227, it is recommended that the resistor values be limited only by the system noise requirements with the caveat that the effect of the impedances' parasitic capacitances shouldn't affect the gain below the intended bandwidth. For example, for a feedback resistor of 5k $\Omega$ , a parasitic capacitor of 400fF will impact gain at frequencies above 79MHz.

## TYPICAL APPLICATIONS

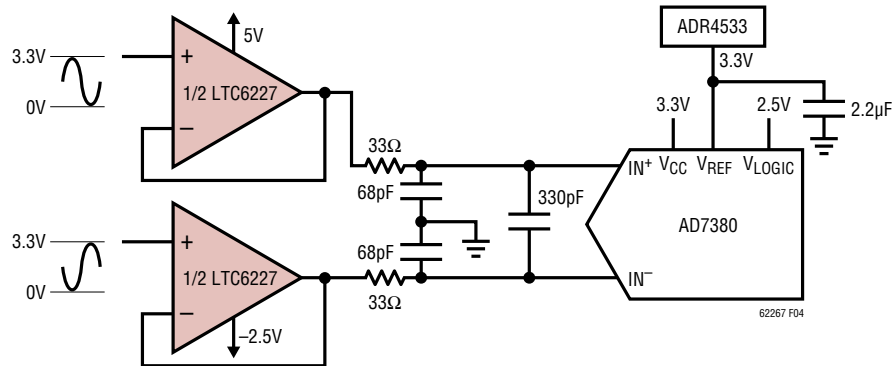


Figure 4. Transparent Driver for 16-Bit ADC

### 16-Bit High Performance Transparent ADC Driver

The ultralow noise and distortion performance of the LTC6226/LTC6227 makes it an excellent candidate for driving high sample rate high resolution ADCs. Figure 4 shows the LTC6227 driven by a differential input, driving an AD7380, a 4Msps, 16-bit ADC. Figure 5 shows the FFT obtained with a  $-0.5$  dBFS, 50kHz input signal. Spurious free dynamic range is an excellent 108.5dB with an SNR of 91dB. Increasing the input frequency to 100kHz results in excellent performance as well, with a THD of  $-100$  dBc, SNR of 89dB and SFDR of 104.9dB.

#### 16-Bit ADC Driver Performance Input Signal = $-0.5$ dBFS $f_{\text{SMPL}} = 4$ Msps, $f_{\text{IN}} = 50$ kHz

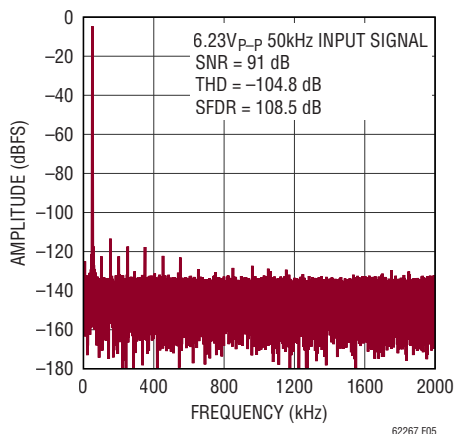


Figure 5. Measured Performance of LTC6227 Based Driver Driving the AD7380

### High Performance Single Ended to Differential 16-Bit ADC Driver

In many applications, the signal to be digitized is single ended, whereas the A/D Converter needs differential inputs to maximize performance. The LTC6227 can be used to implement a Single-Ended to differential ADC driver as shown in Figure 6. One channel is configured in unity gain and drives another channel configured in an inverting gain stage of 1, both outputs drive the LTC2323-16 through an RC filter. Figure 7 shows the FFT obtained with a  $-1$  dBFS 156.25kHz input signal, with a demanding 5Msps sample rate. The obtained SNR of 81 dB is equivalent to that of the ADC by itself, thus there is no degradation due to the driver. The SFDR obtained is 84dB.

## TYPICAL APPLICATIONS

### High Speed Low Voltage Low Noise Instrumentation Amplifier with High CMRR

Figure 8 shows a three op amp instrumentation amplifier with a gain of 10V/V which can operate on a wide range of supply voltages. The resistors are implemented using instances of the LT5401, a matched resistor array chip. The resistor matching of U3 is crucial in achieving high common mode rejection. The front end gain stage resistors were also implemented using instances of the LT5401, but can be implemented using other means as well, since they are not crucial for common mode

rejection. Implementing them using the LT5401 minimizes gain variation across temperature. The amplifiers were implemented using instances of the LTC6227MS8, and supply voltages of  $\pm 1.5V$  were used. Figure 9 shows the measured frequency response, and Figure 10 shows the measured CMRR of the instrumentation amplifier, with the single ended output observed. Figure 11 shows the transient response for a 150mV<sub>p-p</sub> input square wave. The low offset and 1/f noise allow for wide band operation down to DC. The broadband input referred noise of 4.6nV/ $\sqrt{Hz}$  is dominated by the resistors.

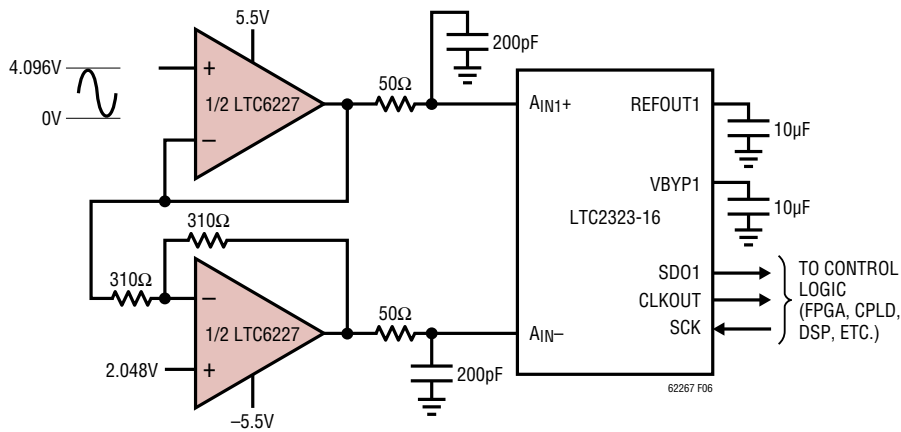


Figure 6. Single-Ended to Differential Driver for 16-Bit ADC

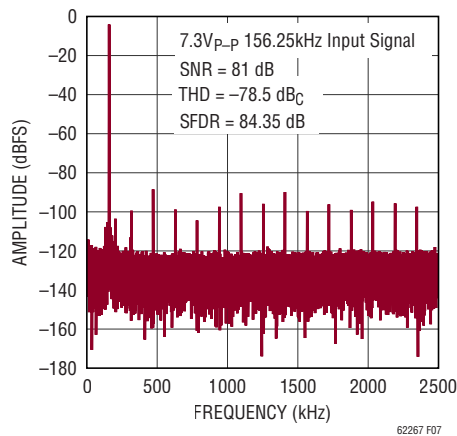


Figure 7. Measured Performance of the LTC6227 Based Single-Ended to Differential Converter Driving the LTC2323-16 ADC

# TYPICAL APPLICATIONS

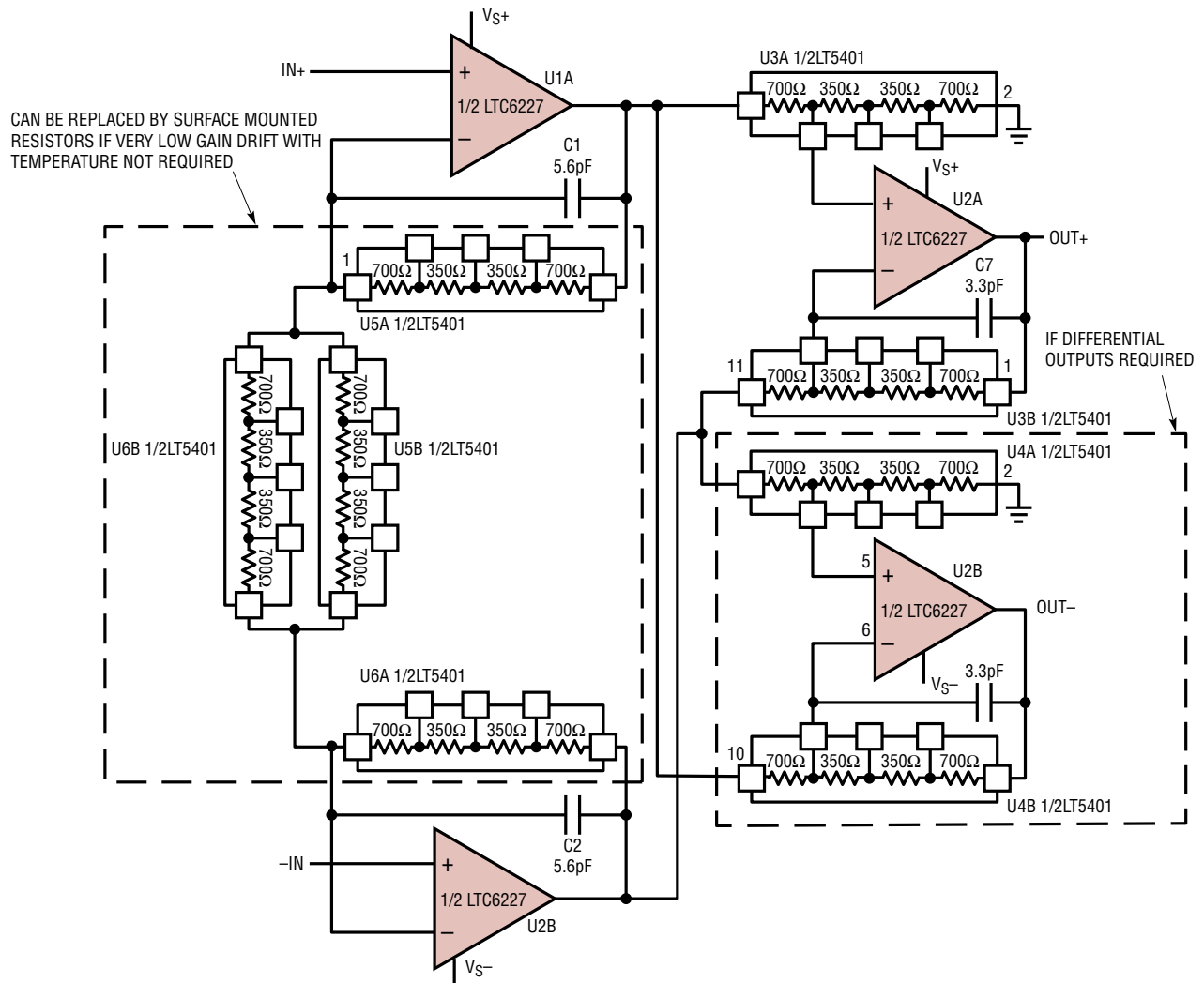


Figure 8. High Speed High CMRR Instrumentation Amplifier

## TYPICAL APPLICATIONS

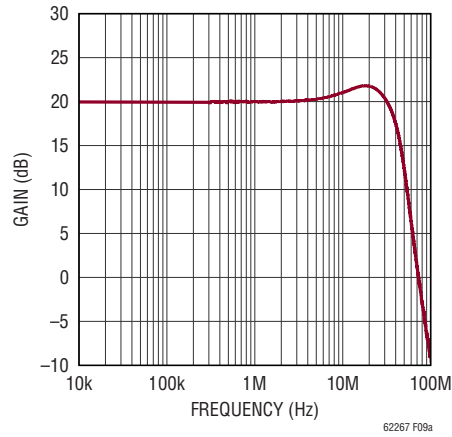


Figure 9. LTC6227-LT5401 Based Instrumentation Amplifier Frequency Response

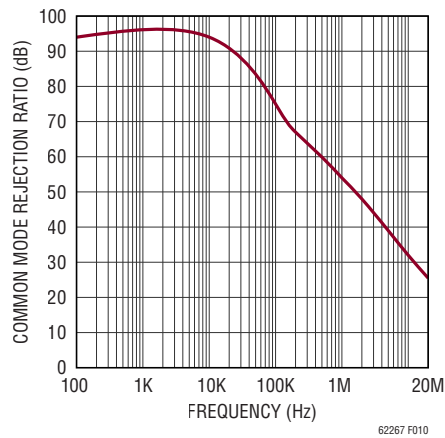


Figure 10. LTC6227-LT5401 Based Instrumentation Amplifier CMRR

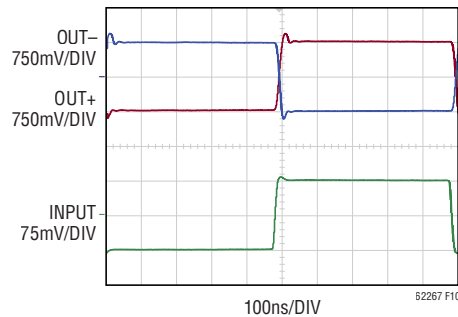
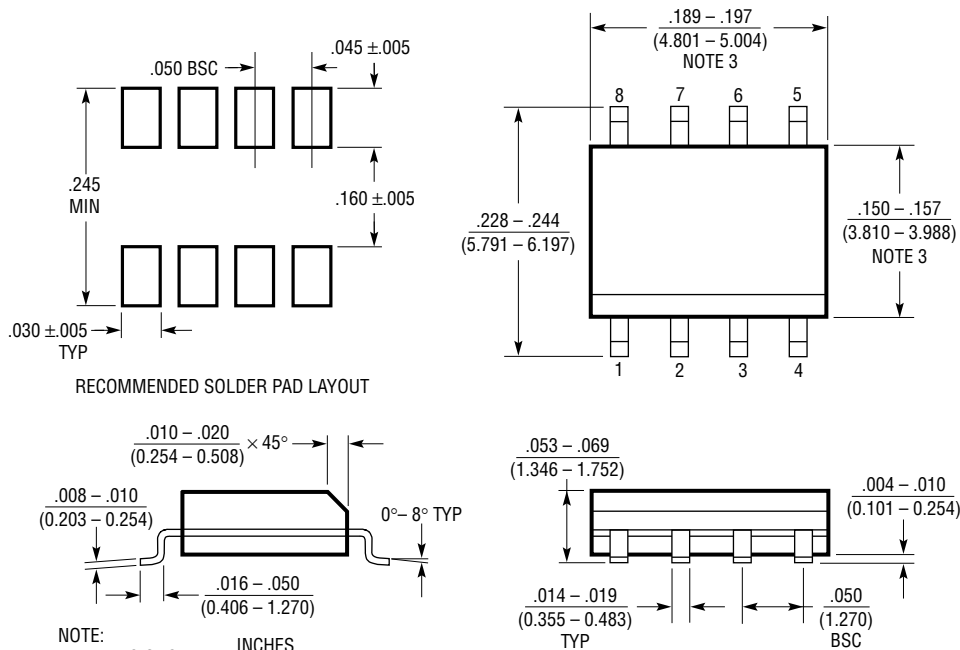


Figure 11. LTC6227-LT5401 Based Instrumentation Amplifier Transient Response

# PACKAGE DESCRIPTION

## S8 Package 8-Lead Plastic Small Outline (Narrow .150 Inch) (Reference LTC DWG # 05-08-1610 Rev G)

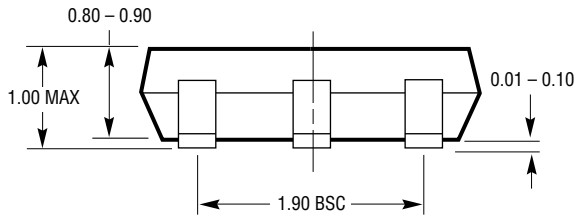
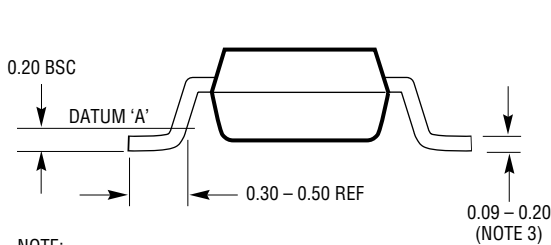
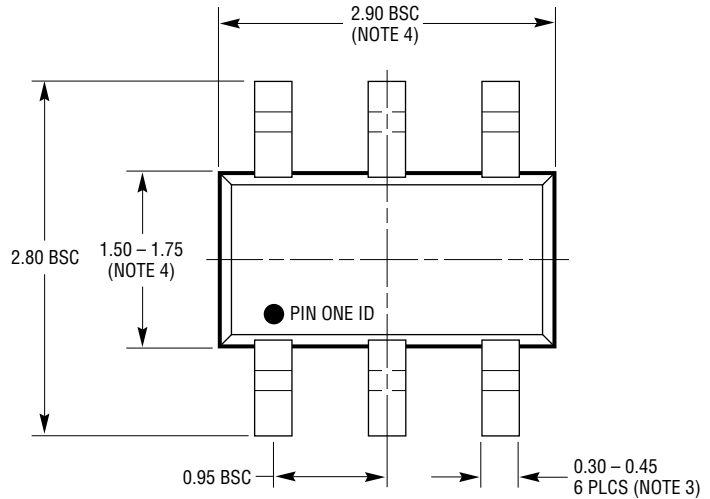
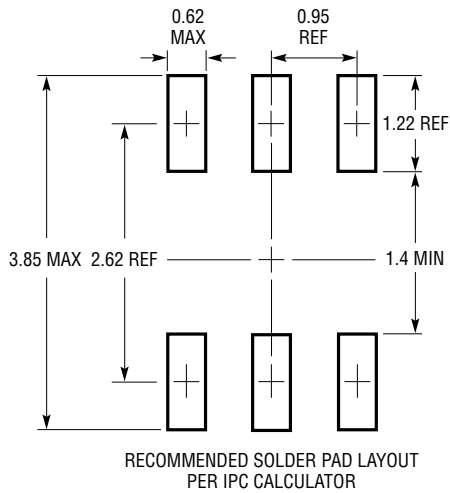


- NOTE:
1. DIMENSIONS IN INCHES (MILLIMETERS)
  2. DRAWING NOT TO SCALE
  3. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)
  4. PIN 1 CAN BE BEVEL EDGE OR A DIMPLE

S08 REV G 0212

**PACKAGE DESCRIPTION**

**S6 Package**  
**6-Lead Plastic TSOT-23**  
 (Reference LTC DWG # 05-08-1636)



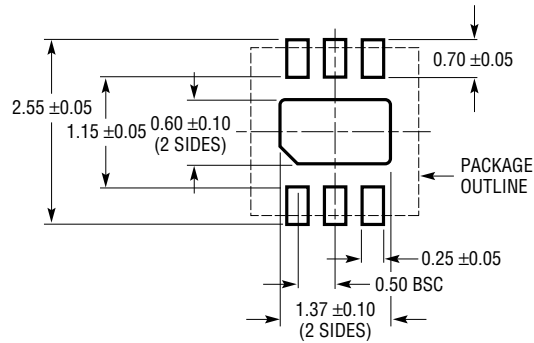
S6 TSOT-23 0302

- NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
  2. DRAWING NOT TO SCALE
  3. DIMENSIONS ARE INCLUSIVE OF PLATING
  4. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
  5. MOLD FLASH SHALL NOT EXCEED 0.254mm
  6. JEDEC PACKAGE REFERENCE IS MO-193

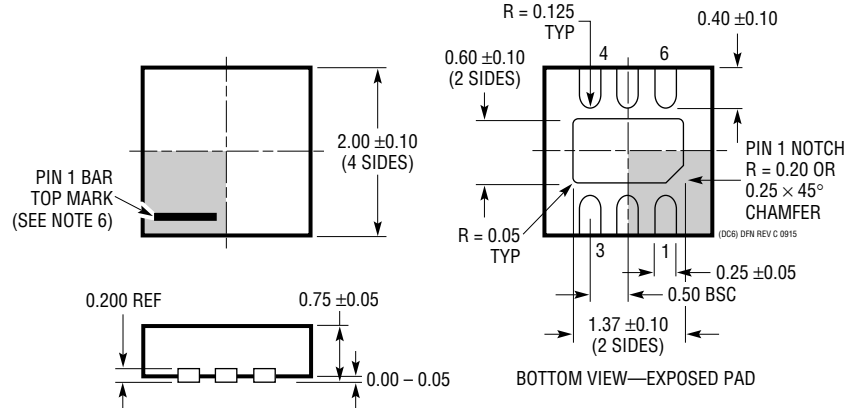


## PACKAGE DESCRIPTION

**DC6 Package**  
**6-Lead Plastic DFN (2mm × 2mm)**  
 (Reference LTC DWG # 05-08-1703 Rev C)



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS

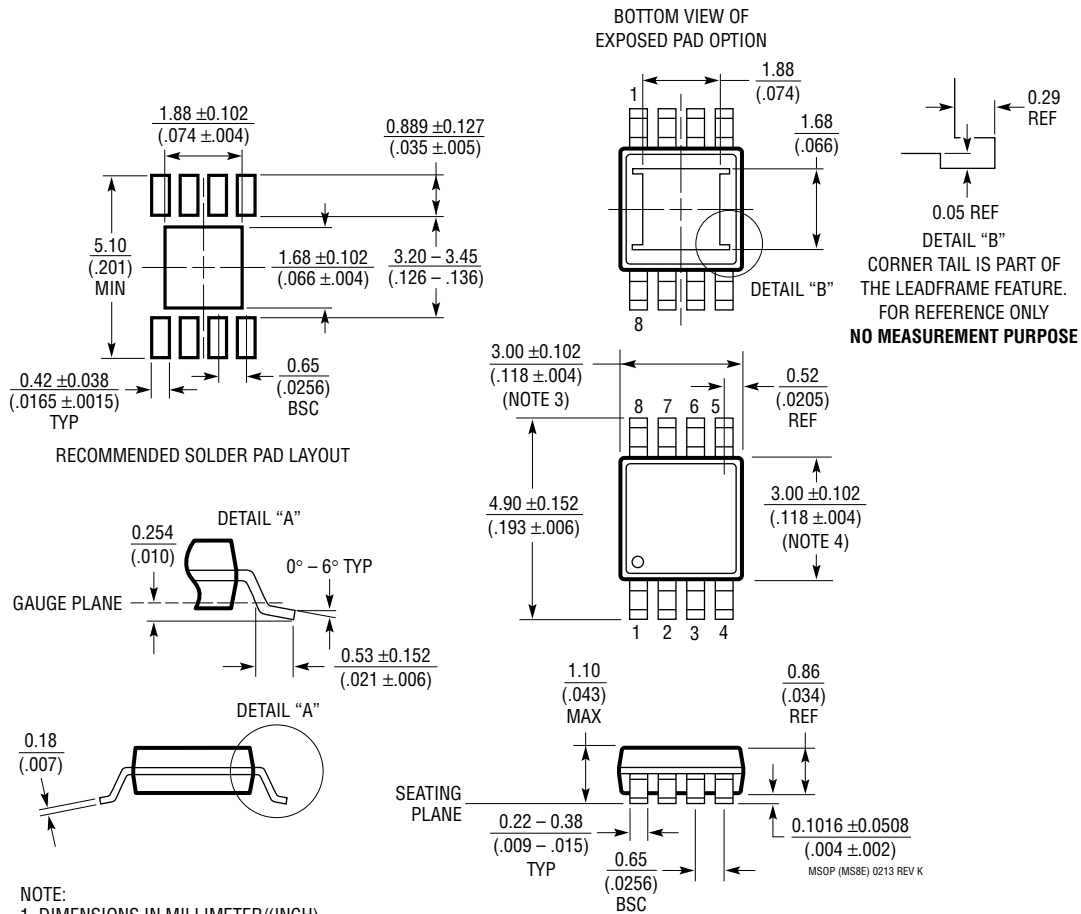


**NOTE:**

1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE M0-229 VARIATION OF (WCCD-2)
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

**PACKAGE DESCRIPTION**

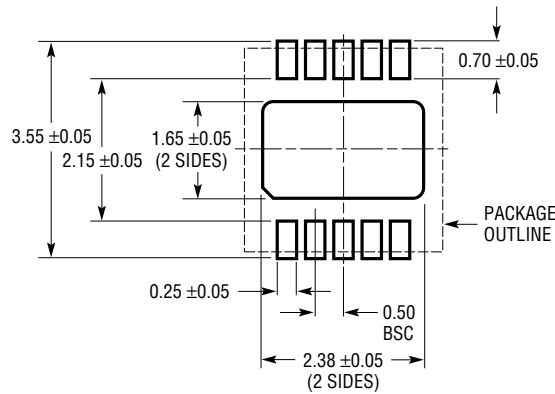
**MS8E Package**  
**8-Lead Plastic MSOP, Exposed Die Pad**  
 (Reference LTC DWG # 05-08-1662 Rev K)



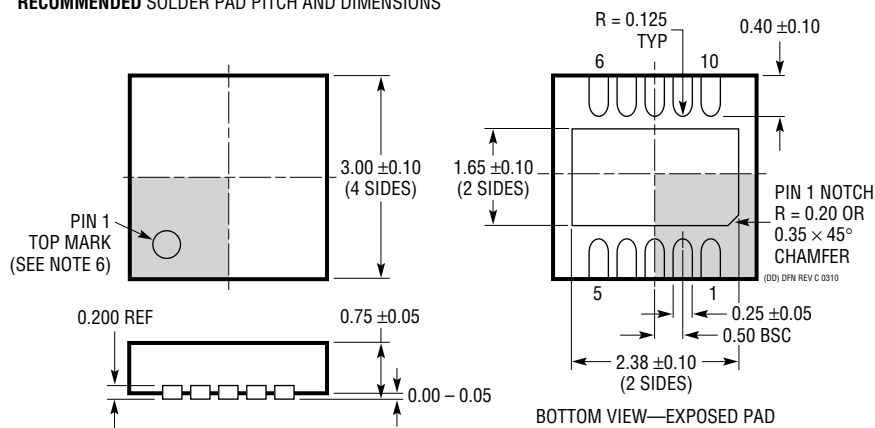
- NOTE:
1. DIMENSIONS IN MILLIMETER/(INCH)
  2. DRAWING NOT TO SCALE
  3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
  4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS. INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
  5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX
  6. EXPOSED PAD DIMENSION DOES INCLUDE MOLD FLASH. MOLD FLASH ON E-PAD SHALL NOT EXCEED 0.254mm (.010") PER SIDE.

# PACKAGE DESCRIPTION

**DD Package**  
**10-Lead Plastic DFN (3mm × 3mm)**  
 (Reference LTC DWG # 05-08-1699 Rev C)



**RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS**



**NOTE:**

1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE M0-229 VARIATION OF (WEED-2). CHECK THE LTC WEBSITE DATA SHEET FOR CURRENT STATUS OF VARIATION ASSIGNMENT
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE